

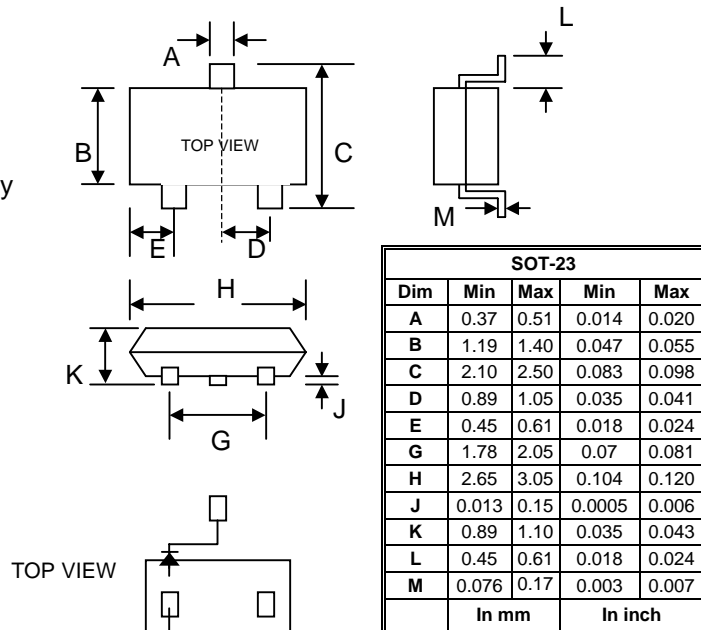
Data Sheet 2771, Rev. -

Features

- High Conductance
- Fast Switching
- Surface Mount Package Ideally Suited for Automatic Insertion
- For General Purpose and Switching
- Plastic Material – UL Recognition Flammability Classification 94V-O

Mechanical Data

- Case: SOT-23, Molded Plastic
- Terminals: Plated Leads Solderable per MIL-STD-202, Method 208
- Polarity: See Diagram
- Weight: 0.008 grams (approx.)
- Mounting Position: Any
- Marking: A2



Maximum Ratings @T_A=25°C unless otherwise specified

Characteristic	Symbol	Value		Unit
Non-Repetitive Peak Reverse Voltage	V _{RM}	100		V
Peak Repetitive Reverse Voltage	V _{RRM}	50	BAV74	V
Working Peak Reverse Voltage	V _{RWM}	70	BAV70	
DC Blocking Voltage	V _R			
Forward Continuous Current (Note 1)	I _F	200		mA
Average Rectified Output Current (Note 1)	I _O	200		mA
Peak Forward Surge Current (Note 1)	I _{FSM}	1.0	Pulse Width=1.0 s	A
		2.0	Pulse Width=1.0 ms	
Power Dissipation (Note 1)	P _d	350		mW
Typical Thermal Resistance, Junction to Ambient Air (Note 1)	R _{θJA}	357		°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-55 to +150		°C

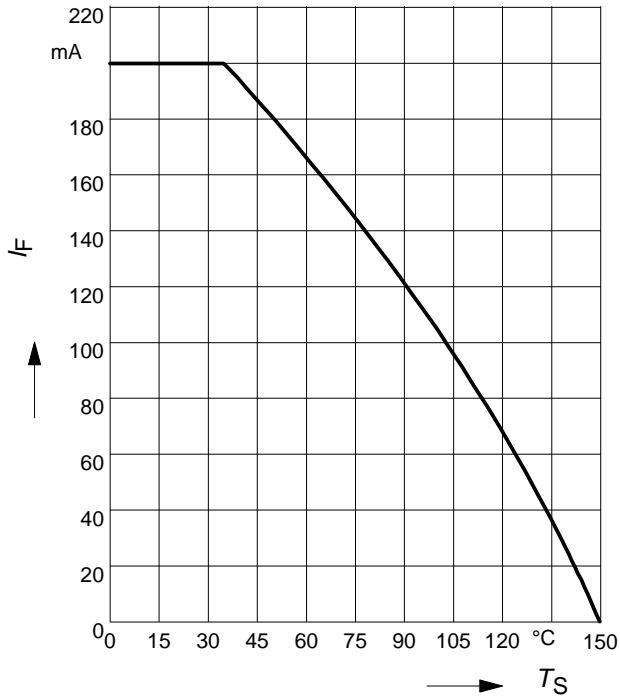
Electrical Characteristics @T_A=25°C unless otherwise specified

Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage	V _{(BR)R}	70(BAV70) 50(BAV74)	—	V	@ I _{RS} = 100μA
Forward Voltage	V _F	—	1.0(BAV70) 150(BAV74)	V	@ I _F = 50mA (BAV70) @ I _F = 100mA (BAV74)
Reverse Leakage Current	I _R	—	5.0(BAV70) 100(BAV74)	μA	@ V _R = 70V (BAV70) @ V _R = 50V (BAV74)
Junction Capacitance	C _j	—	1.5(BAV70) 2.0(BAV74)	pF	V _R = 0V, f = 1.0MHz
Reverse Recovery Time	t _{rr}	—	6.0(BAV70) 4.0(BAV74)	nS	I _F = I _R = 10mA, I _{RR} = 0.1 x I _R , R _L = 100Ω

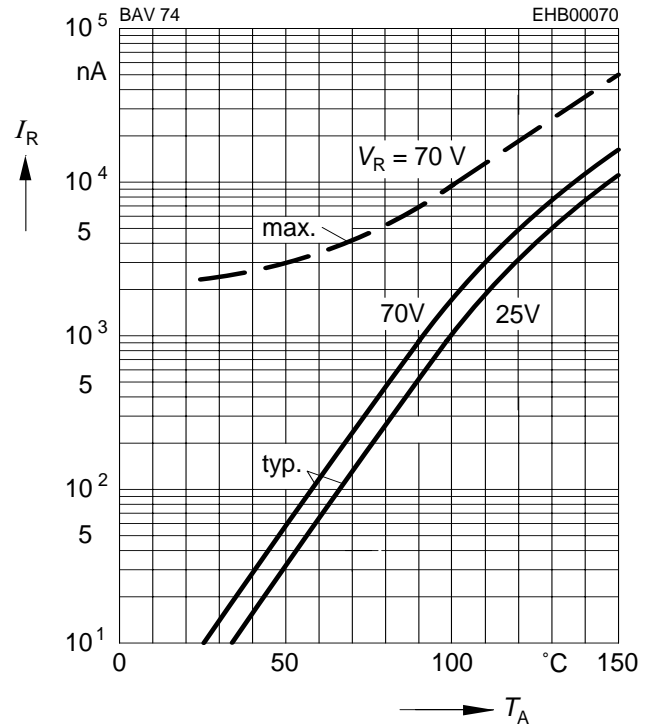
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Note: 1. Device mounted on fiberglass substrate 40 x 40 x 1.5mm.

Forward current $I_F = f(T_S)$

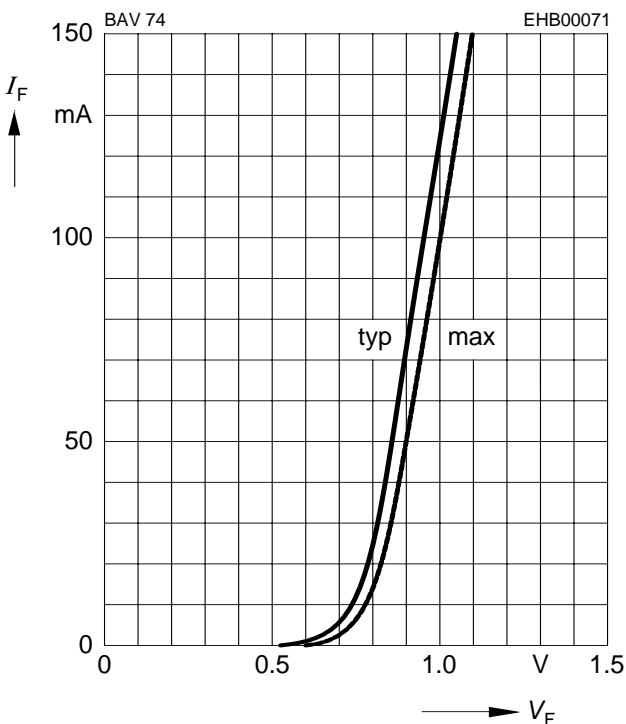


Reverse current $I_R = f(T_A)$



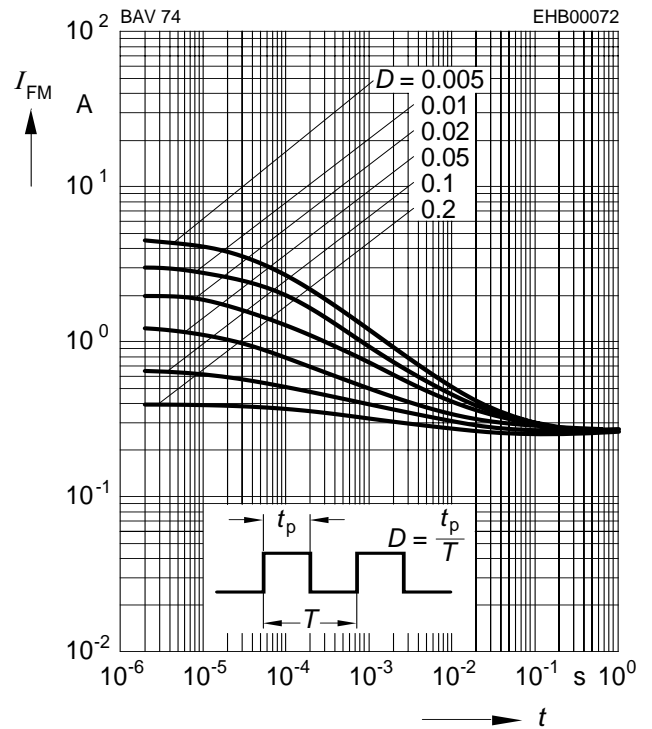
Forward current $I_F = f(V_F)$

$T_A = 25^\circ\text{C}$



Peak forward current $I_{FM} = f(t_p)$

$T_A = 25^\circ\text{C}$



TECHNICAL DATA

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